

Applications

- IEEE802.11b DSSS WLAN
- IEEE802.11g,n OFDM WLAN
- Embedded applications with Bluetooth (Mobile)

Features

- Dual Mode IEEE802.11b & IEEE802.11g
- Integrated PA, Harmonic Filter, LNA and BT port
- Integrated Positive Slope Power Detector
- 19 dBm @ 4.0 % EVM, 802.11g, 54 Mbps
- Simultaneous WLAN and Bluetooth receive mode
- Direct connection to battery with 3.3 V nominal supply
- Lead free, Halogen free and RoHS compliant
- Compact package, 3 x 3 x 0.5 mm, MSL 1

Ordering Information

Part No.	Package	Remark
SE2579U	20 pin QFN	Samples
SE2579U-R	20 pin QFN	Tape and Reel
SE2579U-EK1	N/A	Evaluation kit

Product Description

The SE2579U is a complete 802.11 b/g/n WLAN RF front-end module with a Bluetooth port. The device provides all the functionality of the power amplifier, power detector, filter, Switch, Low Noise Amplifier, 2170 MHz notch filtering and associated matching. The SE2579U provides a complete 2.4 GHz WLAN RF solution from the output of the transceiver to the antennas, and from the antennas to the input of the transceiver, in an ultra compact form factor.

The SE2579U is designed for ease of use, with all the critical matching and harmonic filtering integrated, also offering a simple 50 Ω interface to the antenna.

The SE2579U includes a low noise amplifier to increase the receive sensitivity of embedded solutions to improve range or to overcome the insertion loss of cellular filters often included for mobile applications. It offers simultaneous WLAN and Bluetooth receive mode.

The SE2579U also includes a transmitter power detector with 20 dB of dynamic range and a digital enable control for transmitter power ramp on/off control. The power ramp rise/fall time is 0.5 µs typical.

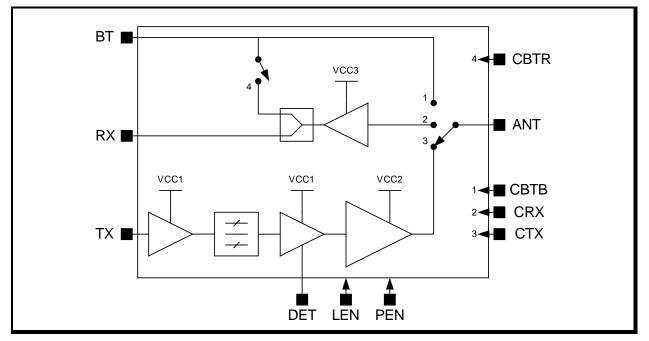
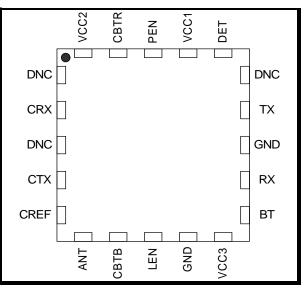


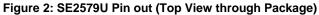
Figure 1: Functional Block Diagram

Functional Block Diagram



Pin Out Diagram









Pin Out Description

Pin No.	Name	Description
1	DNC	Do Not Connect
2	CRX	WLAN Receive antenna switch control
3	DNC	Do Not Connect
4	СТХ	WLAN Transmit antenna switch control
5	CREF	Control pin reference 'high' level input
6	ANT	Antenna Port (must be AC-coupled)
7	CBTB	Bluetooth antenna switch control
8	LEN	LNA Enable
9	GND	Ground
10	VCC3	LNA Power Supply
11	BT	Bluetooth Port (must be AC coupled)
12	RX	WLAN Receive Port (must be AC-coupled)
13	GND	Ground
14	ТΧ	WLAN Transmit Port (must be AC-coupled)
15	DNC	Do Not Connect
16	DET	Transmit Power Detector Output
17	VCC1	Power Amplifier Power Supply
18	PEN	Power Amplifier Enable
19	CBTR	Bluetooth back-end switch control
20	VCC2	Power Amplifier Power Supply
Die paddle	GND	Ground



Absolute Maximum Ratings

These are stress ratings only. Exposure to stresses beyond these maximum ratings may cause permanent damage to, or affect the reliability of the device. Avoid operating the device outside the recommended operating conditions defined below. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Definition	Min.	Max.	Unit
VCC	Supply Voltage on VCC	-0.3	5.5	V
Vin	DC input on control pins	-0.3	3.6	V
P _{TXIN}	TX Input Power, ANT terminated in 50Ω match	-	5	dBm
TA	Operating Temperature Range	-30	85	°C
Тѕтс	Storage Temperature Range	-40	150	°C
ESD _{HBM}	JEDEC JESD22-A114 All pins except ANT, CBTB, LEN, Vcc3,BT, RX pins ANT, BT pins with recommended application circuit ANT, CBTB, LEN, Vcc3, BT, RX pins		1000 1000 400	V

Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
TA	Ambient temperature	-30	25	85	°C
Vcc	Supply voltage, relative to $GND = 0 V$	2.7	3.3	4.8	V

DC Electrical Characteristics

Conditions: Vcc = PEN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2579U-EK1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
lcc-g	Total Supply Current	POUT = 18 dBm, 54 Mbps OFDM signal, 64QAM	-	185	210	mA
Ісс-в	Total Supply Current	P _{OUT} = 20 dBm, 11 Mbps CCK signal, BT = 0.45	-	215	248	mA
Ι _{CQ}	Quiescent Current	No RF	-	133	148	mA
ICC_OFF	Total Supply Current	PEN = 0 V, No RF Applied, CBTR = CBTB = CTX =CRX= 0 V	-	5	10	μΑ
lcc_LNA	Total Supply Current	LEN = Vcc	-	8	12	mA
ICC_LNA_ BYP	Total Supply Current in bypass mode	LEN = 0 V	-	50	100	μΑ



Control Logic Characteristics

Conditions: Vcc = PEN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2579U-EK1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Vін	Logic High Voltage	-	2.7.	-	3.3	V
VIL	Logic Low Voltage	-	0	-	0.4	V
Ін	Input Current Logic High Voltage	-	-		10	μΑ
lı.	Input Current Logic Low Voltage	-	-		1	μA

Control Logic Table

Mode#	Mode Description	СТХ	CRX	CBTB	CREF	PEN	LEN	CBTR
0	All Off	0	0	0	Х	0	0	0
1	BT	0	0	1	1	0	0	0
2	WLAN Rx, high gain	0	1	0	1	0	1	0
3	WLAN Rx, low gain	0	1	0	1	0	0	0
4	WLAN TX	1	0	0	1	0	0	0
5	WLAN TX + PA enabled	1	0	0	1	1	0	0
6	(BT+WLAN) Rx, high gain	0	1	0	1	0	1	1
7	(BT+WLAN) Rx, low gain	0	1	0	1	0	0	1
8	ANT to (BT+WLAN) connect	0	0	1	1	0	0	1

AC Electrical Characteristics

802.11g Transmit Characteristics

Conditions: Vcc = PEN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2579U-EK1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fin	Frequency Range	-	2400	-	2500	MHz
		VCC = 3.3 V, Pout = 19 dBm, 54 Mbps OFDM signal, 64 QAM				
EVM	EVM	Vcc = 3.0V, POUT = 18 dBm, 54Mbps, OFDM signal, 64 QAM	-	-	4	%
		Vcc = 2.7V, POUT = 17 dBm, 54Mbps, OFDM signal, 64 QAM				



Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
ACPRb	Adjacent Channel Power Ratio 11b	Pout = 20dBm, 11Mbps CCK, BT = 0.45 ±11 MHz offset ±22 MHz offset	-	-37 -58	-32 -55	dBc	
ACPRg	Adjacent Channel Power Ratio 11g	Pout = 18 dBm, 54 Mbps OFDM, 64QAM ±11 MHz offset ±20 MHz offset ±30 MHz offset			-20 -28 -40	dBc	
P _{max-} OOB	Out-of-band limited output power	11g - 54 Mbps 11b – 11 Mbps PSD _{ООВ} = -43 dBm/MHz, RB = 1 MHz 2310-2390 MHz 2483.5-2500 MHz	16 20	17 20	-	dBm	
S 21	Small Signal Gain	-	25	27	30	dB	
ΔS_{21}	Small Signal Gain Variation Over Band	-	-	-	1.5	dBpp	
2f		Pout = 20 dBm, 1 Mbps, 802.11b	-	-35	-25	dBm/MHz	
Зf	Harmonics	Pout = 18 dBm, 54Mbps OFDM signal, 64 QAM		-52	-43	dBm/MHz	
tdr, tdf	Delay and rise/fall Time	50 % of VPEN edge and 90/10 % of final output power level	-	0.5	1	μs	
S11	Input Return Loss	TX port	-	-15	-10	dB	
S _{21WCDMA}	Small Signal Gain in WCDMA band	2110-2170 MHz, relative to min in-band gain			-11	dBr	
PNWCDMA	Output noise power in WCDMA band	2110-2170 MHz Роит = 20 dBm, 1 Mbps, 802.11b Роит = 18 dBm, 54Mbps OFDM signal, 64 QAM		-130	-127	dBm/Hz	
STAB	Stability	CW, Pin = -5 dBm 0.1 GHz - 20 GHz Load VSWR = 6:1	All non-harmonically related outputs less than -43 dBm/MHz				
RGGD	Ruggedness	CW, PIN = -5 dBm 0.1 GHz - 20 GHz Load VSWR = 10:1	No perma degradati	No permanent damage or performance degradation			

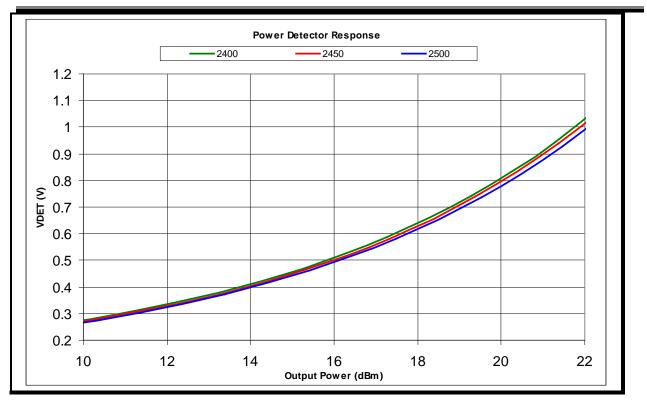


Power Detector Characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fout	Frequency Range	-	2400	-	2500	MHz
PDR	Power detect range, CW	Measured at ANT	0	-	22	dBm
PDZLOAD	Output Impedance	-		2.2		KΩ
PDVNORF	Output Voltage, Pout = No RF	Measured in to $1M\Omega$	0.1	0.125	0.150	V
PDV _{p18.5}	Output Voltage, Pout = 18.5 dBm CW	Measured in to $1M\Omega$	0.56	0.66	0.76	V
PDV _{p20}	Output Voltage, Pour = 20 dBm CW	Measured in to 1MΩ	0.70	0.80	0.90	V
PD _{tTVAR}	Detector variation over temperature	-30 to 25 deg C 25 to 85 deg C given detector voltage	-0.6		+0.5	dB
PD _{FVAR}	Detector variation over frequency	2400-2500 MHz given detector voltage	-0.5		0.5	dB
PD _{vswr}	Detector variation over load VSWR	Forward power ANT VSWR 3:1 all phases given detector voltage	-2		+1	dB
PD_BW	Detector bandwidth			1		MHz

Conditions: Vcc = PEN = 3.3 V. TA = 25 °C. as measured on Skyworks Solutions' SE2579U-EK1 evaluation board





DATA SHEET SE2579U: 2.4 GHz High Efficiency Wireless LAN/BT Front-End

Figure 3: Power Detector Characteristic



Bluetooth Characteristics

Conditions: Vcc = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2579U-EK1 evaluation board (deembedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fout	Frequency Range	-	2400	-	2500	MHz
BTı∟	Insertion Loss	BT-ANT, CBTB=hi, CBTR=CTX=CRX=lo	-	1.2	1.5	dB
S ₁₁	BT Port Return Loss	CBTB=hi, CBTR=CTX=CRX=lo			-12	dB
ISOL _{SW}	Switch Isolation	ANT-RX, CBTB=hi, CBTR=CTX=CRX=lo	20			dB

2.4 GHz Receive Characteristics

Conditions: VCC = 3.3 V, LEN = CRX = CBTR= CREF= 3.3V, PEN = CBTB = CTX = 0 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2579U-EK1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fout	Frequency Range	-	2400	-	2500	MHz
	Receive Gain, LNA	(BT+WLAN) Rx, high gain	11	13	15	dB
S21	enabled.	WLAN Rx, high gain only, LEN = CRX = CREF= 3.3V, PEN = CBTB = CTX =CBTR= 0 V	14	16	18	dB
ΔS 21	Gain Variation	2400 – 2485 MHz, Over any 20MHz band	-	-	0.5	dB
NF	Noise Figure		-	2.0	2.5	dB
IIP3	Third Order Intercept		-3		-	dBm
S11	Input Return Loss	-			-10	dB
S ₁₂	Reverse Isolation				-20	dB
IP1dB	Input P1dB	CW	-13			dBm
T _{EN}	Enable Time	10% to 90% of RX RF power, from time that LEN is at 50%			500	nsec
S21-BYP	Receive Gain, LNA bypassed	LEN = 0 V	-20		-10	dB
S11-BYP	Input Return Loss, LNA bypassed	LEN = 0 V			-7	dB
ISOL _{sw}	Switch Isolation	CBTB=CBTR=lo, CRX=hi, ANT-BT + BT-RX	20			dB



Package Handling Information

Branding Information

The device branding is shown in Figure 4.

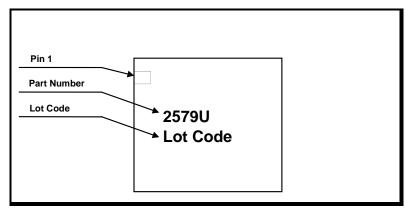
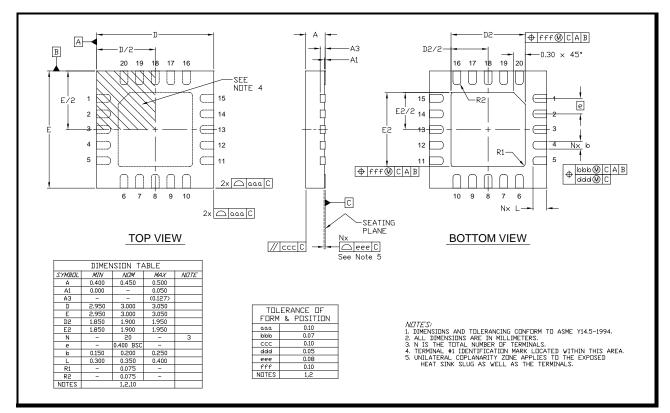


Figure 4: SE2579U Branding and Pin 1 Location

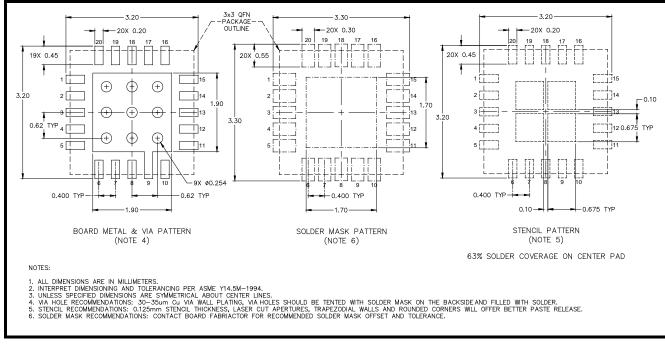
Package Diagram

The package diagram is shown in Figure 5.









Recommended PCB Footprint and Solder pattern

Package Handling Information

Because of its sensitivity to moisture absorption, instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly. The SE2579U is capable of withstanding a Pb free solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is manually attached, precaution should be taken to insure that the device is not subjected to temperatures above its rated peak temperature for an extended period of time. For details on both attachment techniques, precautions, and handling procedures recommended, please refer to:

- "QFN solder reflow and rework information application note", Document Number QAD-00045
- "Handling, packing, shipping and use of moisture sensitive QFN application note", **Document Number** QAD-00044



Tape and Reel Information

Parameter	Value
Devices Per Reel	3000
Reel Diameter	13 inches
Tape Width	12 millimeters

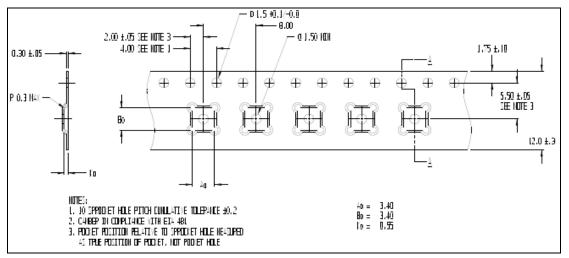


Figure 7: SE2579U-R Tape and Reel Information.

Document Change History

Revision	Date	Notes
1.0	03/02/2009	Initial Release
1.1	3/17/2009	Updated specification
1.2	04/06/2009	Updated maximum control pin voltage to 3.6V
1.3	05/27/2009	Updated specification, and updated back page
1.4	06/25/2009	Updated ESD specification
1.5	08/26/2009	Updated ACPRb specification
1.6	09/20/2009	Updated Power detector specification, and pcb footprint recommendation
1.7	Jan-12-2010	Clarified ESD ratings
1.8	Apr-10-2012	Updated with Skyworks logo and disclaimer statement



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